

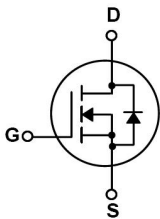
/ Descriptions

/ Features

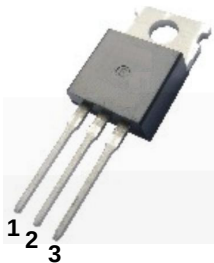
/ Applications

DC/DC

/ Equivalent Circuit



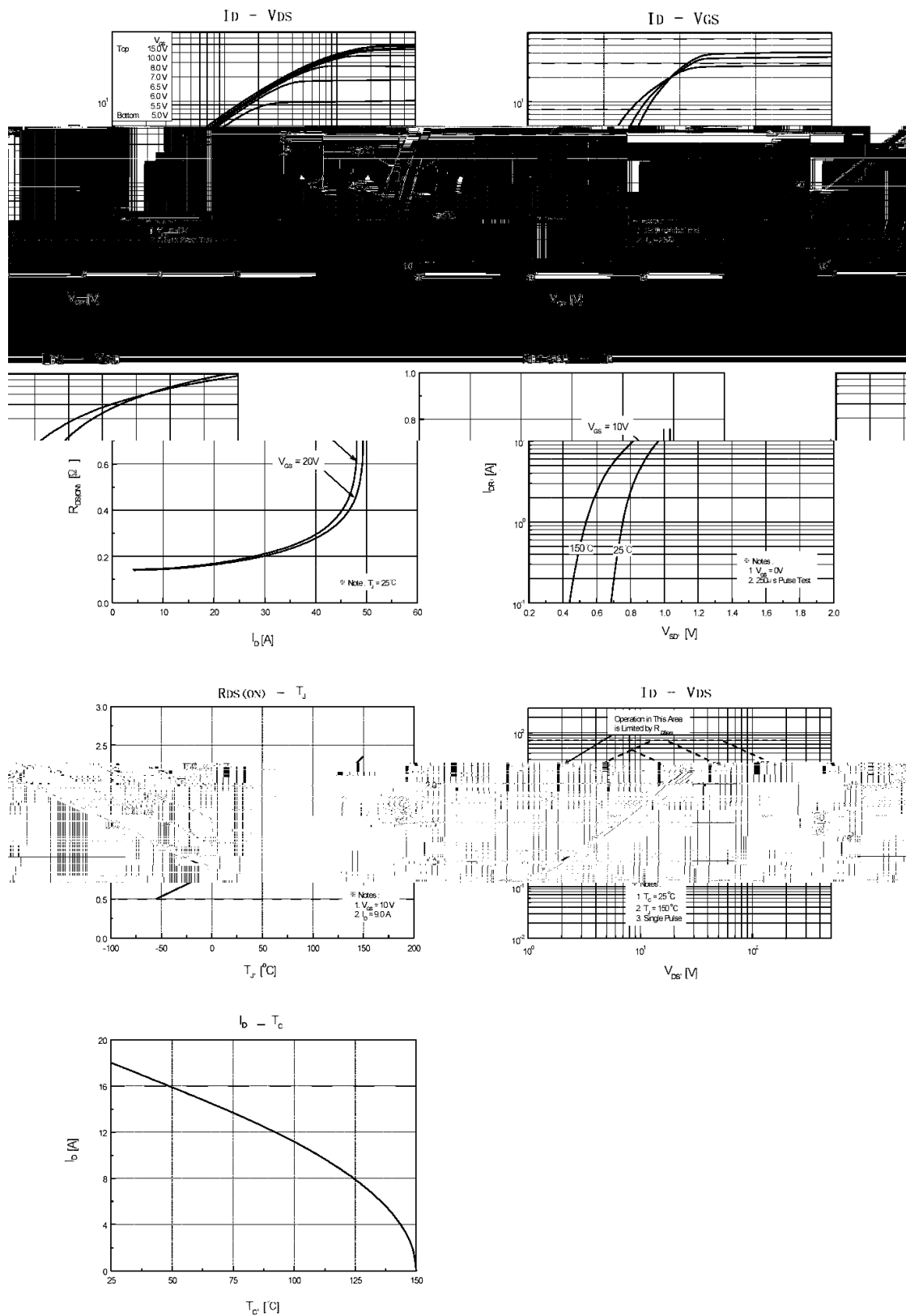
/ Pinning



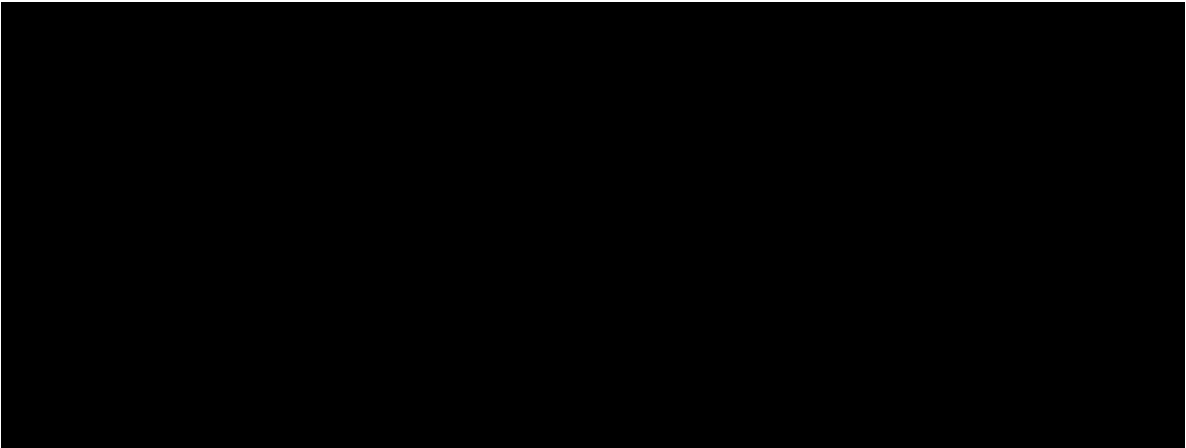
/ h_{FE} Classifications & Marking

		μ				
						μ
						μ
						μ
		μ				

/ Electrical Characteristic Curve

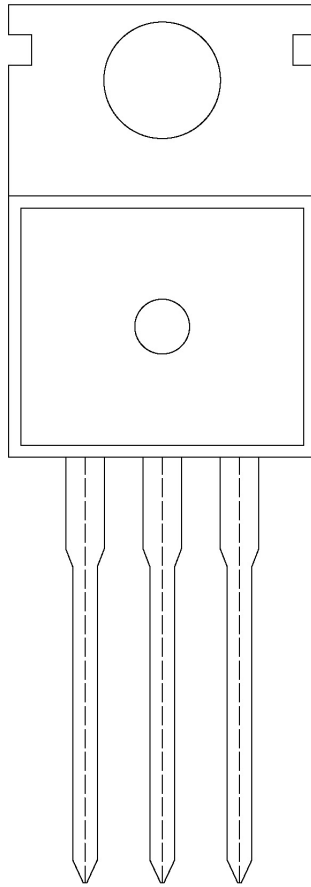


/ Package Dimensions



Dimensions in Millimeters			Dimensions in Millimeters		
Symbol	Min	Max	Symbol	Min	Max
Δ	9.8	10.2	C	0.2	1.4
ϕ	2.54	2.64	ϕ	6.3	6.57
ϕ	9.4	15.74	B	9.02	
ϕ	2.6		G1	2.2	
ϕ	0.9		ϕ	0.7	
ϕ	0.6		ϕ	1.32	
ϕ	1.25	1.47	E	2.34	2.74
			ϕ	1.25	1.45

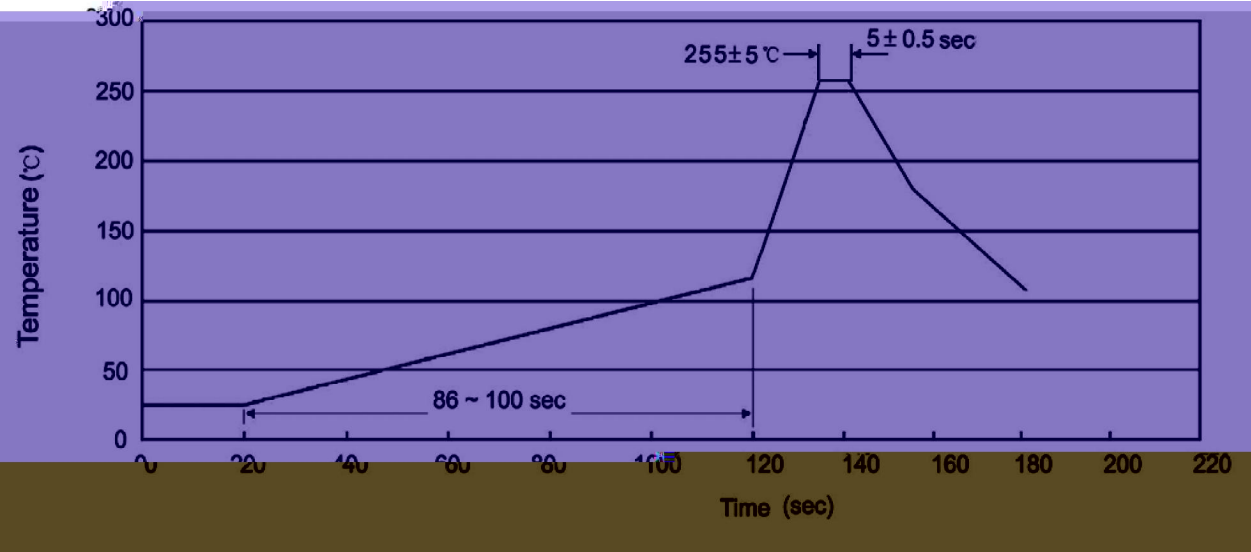
/ Marking Instructions



IRF640

IRF640

() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 袋	袋 盒	只 盒	盒 箱	只 箱	袋	盒	箱

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

/ Notices